TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

T C 7 W T 1 2 5 F U

DUAL BUS BUFFER

The TC7WT125FU is a high speed CMOS DUAL BUS BUFFERS fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input threshold levels are compatible with TTL output voltage.

The require 3-state control input \overline{G} to be set high to place the output into the high impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



FEATURES

- High Speed \cdots t_{pd} = 13ns (Typ.) at V_{CC} = 5V
- Low Power Dissipation $\dots I_{CC} = 2\mu A$ (Max.) at Ta = 25°C
- Compatible with TTL outputs \cdots V_{IL} = 0.8V (Max.), V_{IH} = 2.0V (Min.)
- Output Drive Capability 15 LSTTL Loads
- Symmetrical Output Impedance… |IOH| = IOL = 6mA (Min.)

MAXIMUM RATINGS (Ta = 25° C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	- 0.5~7	V
DC Input Voltage	VIN	-0.5~V _{CC} +0.5	V
DC Output Voltage	Vout	-0.5~V _{CC} +0.5	V
Input Diode Current	Чк	± 20	mA
Output Diode Current	Іок	± 20	mA
DC Output Current	Ιουτ	± 35	mA
DC V _{CC} /Ground Current	lcc	± 37.5	mA
Power Dissipation	PD	300	mW
Storage Temperature	T _{stg}	- 65~150	°C
Lead Temperature (10 s)	TL	260	°C

MARKING



PIN ASSIGNMENT (TOP VIEW)



LOGIC DIAGRAM



TRUTH TABLE

INP	UTS	OUTPUTS
G	А	Y
Н	×	Z
L	L	L
L	Н	Н

x : Don't Care

Z : High Impedance

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	4.5~5.5	V
Input Voltage	VIN	0~V _{CC}	V
Output Voltage	Vout	0~V _{CC}	V
Operating Temperature	T _{opr}	- 40~85	°C
Input Rise and Fall Time	t _r , t _f	0~500	ns

DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC		YMBOL TEST CONDITION		Vcc	Ta = 25°C			Ta = −40~85°C		UNIT	
CHARACTERISTIC				Vcc (V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT	
High-Level	VIH			4.5~	2.0			2.0		v	
Input Voltage	[♥] IH			5.5	2.0			2.0		v	
Low-Level	VIL			4.5~			0.8		0.8	v	
Input Voltage	^v iL			5.5	_		0.0	_	0.0	v	
High-Level	Val	$V_{IN} = V_{IH}$	I _{OH} = -20μA	4.5	4.4	4.5	—	4.4	—	v	
Output Voltage	∨он	or V _{IL}	I _{OH} = – 6mA	4.5	4.18	4.31	—	4.13	—	v	
Low-Level	N.	Maria Mar	l _{OL} = 20μA	4.5	_	0.0	0.10	—	0.10	v	
Output Voltage	VOL	$V_{IN} = V_{IL}$	I _{OL} = 6mA	4.5	_	0.17	0.26	_	0.33		
3-State Output		V _{IN} = = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_		±0.5	_	± 5.0	μΑ	
Off-State Current	loz										
Input Leakage	1.5.1	V _{IN} = V _{CC} or GND		5.5			±0.1		± 1.0		
Current	IIN			5.5			± 0.1		<u>→</u> 1.0	μΑ	
	Icc	V _{IN} = V _{CC} or GND		5.5	_	—	2.0	—	20.0	μΑ	
Quiescent Supply		PER INPUT	: V _{IN} = 0.5V								
Current	¹ сст		or 2.4V	5.5	_	—	2.0	—	2.9	mA	
OTHER INPUT: VC		JT: V _{CC} or GND									

	CVMDOL	TEST CONDITION		Ta = 25°C			Ta = -40~85°C		UNIT			
CHARACTERISTIC	SYMBOL		CL	Vcc	MIN.	TYP.	MAX.	MIN.	MAX.			
Output Transition	t _{TLH}	ttlh	tTLH	t _{TLH}	50	4.5	—	7	12	—	15	
Time	tTHL		50	5.5	—	6	11	—	14	ns		
		_	50	4.5	—	15	25	—	31	ns		
Propagation Delay	tpLH			5.5	—	13	22	—	28			
Time	t _{pHL}		150	4.5	—	21	33	—	41			
				5.5	—	18	29	_	37			
	^t pZL ^t pZH	$R_L = 1k\Omega$	50 150	4.5	—	17	30	_	38	ns		
Output Enable Time				5.5	—	14	27	_	34			
				4.5	—	23	38	—	48			
				5.5	—	20	34	_	43			
Output Disable Time	^t pLZ ^t pHZ	$R_L = 1k\Omega$	50	4.5	—	16	30	_	38	-		
				5.5	—	13	27	_	34	ns		
Input Capacitance	CIN	—	_	_	—	5	10	—	10	pF		
Output Capacitance	COUT	—	_	_	—	10	—	_	—	рF		
Power Dissipation Capacitance	C _{PD}	(Note 1)	_	_	_	32	_	_	_	pF		

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 6ns$)

(Note 1) : CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation :

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 2$ (per Gate)

PACKAGE DIMENSIONS SSOP8-P-0.65

Unit : mm





Weight : 0.02g (Typ.)

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